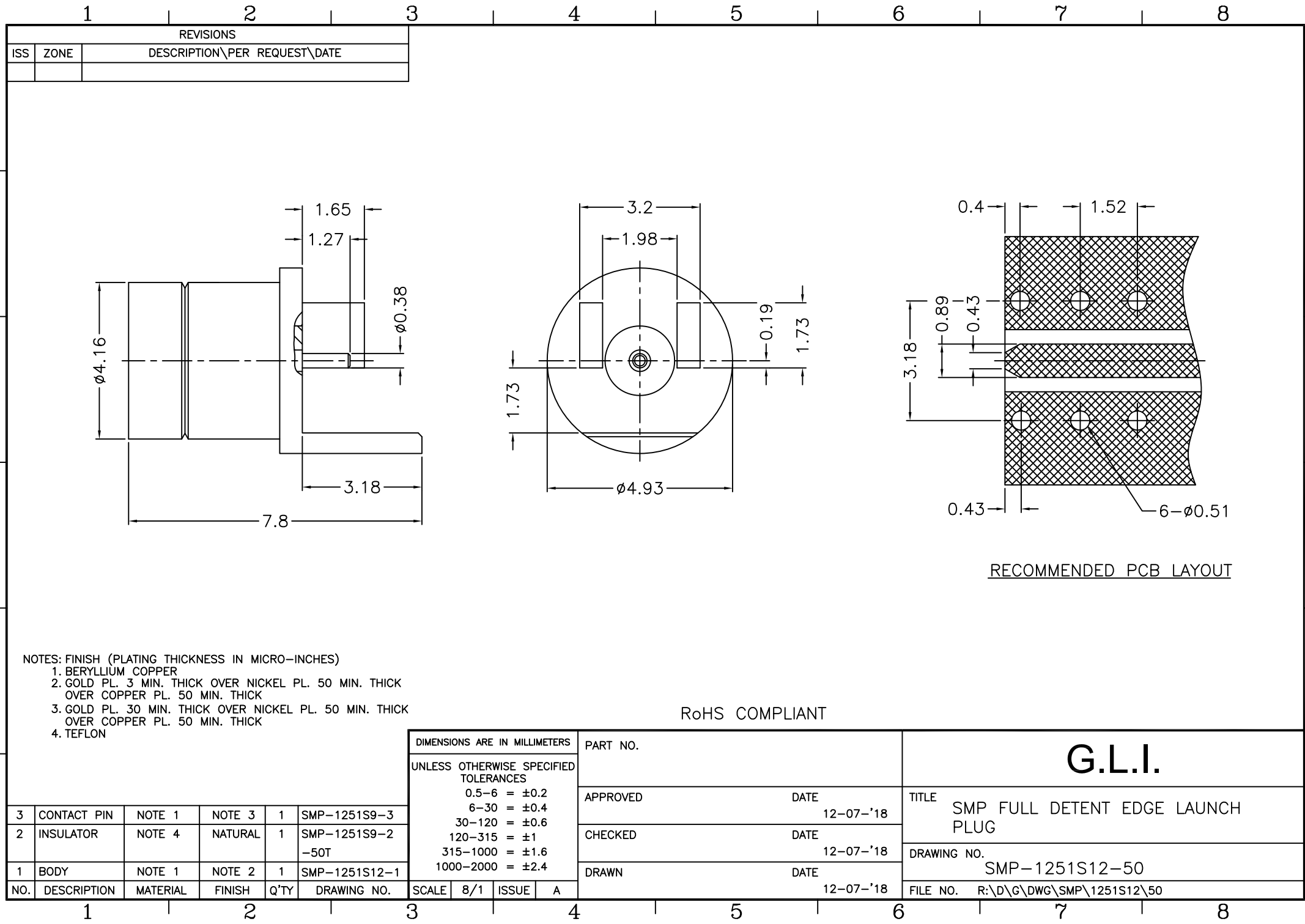




NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)

- 1. BERYLLIUM COPPER
- 2. GOLD PL. 3 MIN. THICK OVER NICKEL PL. 50 MIN. THICK OVER COPPER PL. 50 MIN. THICK
- 3. GOLD PL. 30 MIN. THICK OVER NICKEL PL. 50 MIN. THICK OVER COPPER PL. 50 MIN. THICK
- 4. TEFLON

RoHS COMPLIANT

4. TEFLON						DIMENSIONS ARE IN MILLIMETERS				PART NO.		G.L.I.			
						UNLESS OTHERWISE SPECIFIED TOLERANCES									
						0.5-6 = ±0.2				APPROVED				DATE 12-07-'18	
						6-30 = ±0.4									
30-120 = ±0.6				CHECKED		DATE 12-07-'18									
120-315 = ±1															
315-1000 = ±1.6				DRAWN		DATE 12-07-'18									
1000-2000 = ±2.4															
3	CONTACT PIN	NOTE 1	NOTE 3	1	SMP-1251S9-3	SCALE	8/1	ISSUE	A	TITLE SMP FULL DETENT EDGE LAUNCH PLUG					
2	INSULATOR	NOTE 4	NATURAL	1	SMP-1251S9-2 -50T	DRAWING NO. SMP-1251S12-50									
1	BODY	NOTE 1	NOTE 2	1	SMP-1251S12-1										
NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	DRAWING NO.	FILE NO. R:\D\G\DWG\SMP\1251S12\50									